

# **Specification of Automotive MLCC** (Referance sheet)

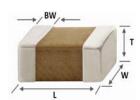


● Supplier : Samsung Electro-Mechanics ● Samsung P/N : CL10B684KO8VPNC

● AEC-Q200 Qualified

#### A. Dimension

#### Dimension



Size	0603 inch		
L	1.60±0.10 mm		
W	0.80±0.10 mm		
Т	0.80±0.10 mm		
BW	0.30±0.20 mm		

### B. Samsung Part Number

<u>CL</u> 10	<u>10</u>	<u>B</u>	<u>684</u>	<u>K</u>	<u>o</u>	<u>8</u>	<u>V</u>	<u>P</u>	<u>N</u>	<u>C</u>
1	2	3	<b>④</b>	(5)	6	7	8	9	10	11

① Series	Samsung Multi-layer Ceramic Capacitor		
② Size	0603 (inch code)	L: 1.60±0.10 mm	W:0.80±0.10 mm
3 Dielectric	X7R	® Inner electrode	Ni
④ Capacitance	680 nF	Termination	Metal-Epoxy
⑤ Capacitance	± 10%	Plating	Sn 100% (Pb Free)
tolerance		Product	Automotive
Rated Voltage	16 V	Special code	Normal
7 Thickness	0.80±0.10 mm	① Packaging	Cardboard Type, 7" Reel

### C. Reliability Test and Judgement condition

Test items	Performance	Test condition		
High Temperature	Appearance : No abnormal exterior appearance	Unpowered, 1,000hrs @ Max. temperature		
Capacitance Change Within ±10 %		Measurement at 24±2hrs after test conclusion		
	Tan δ :0.075 max.			
	IR∶More than 10,000 № or 500 №× <i>µ</i> F	Initial Measurement 2*		
	Whichever is smaller	Final Measurement 3*		
Temperature Cycling	Appearance : No abnormal exterior appearance	1,000Cycles		
	Capacitance Change Within ±10 %	Initial Measurement 2*		
	Tan δ :0.075 max.	Final Measurement 3*		
	IR∶ More than 10,000 ™ or 500 ™× <i>µ</i> F	Measurement at 24±2hrs after test conclusion		
	Whichever is smaller	1 cycle condition : -55+0/-3°C(30±3min) → Room Temp. (1min)		
		→ 125+3/-0°C (30±3min) → Room Temp. (1min)		
Destructive Physical	No Defects or abnormalities	Per EIA 469		
Analysis				
Humidity Bias	Appearance : No abnormal exterior appearance	1,000hrs 85°C/85%RH, Rated Voltage and 1.3~1.5V,		
	Capacitance Change Within ±12.5 %	Add 100kohm resistor		
	Tan δ :0.075 max.	Initial Measurement 2*		
	IR ∶More than 500 MΩ or 25 MΩ×μF	Final Measurement 4*		
	Whichever is smaller	Measurement at 24±2hrs after test conclusion		
		The charge/discharge current is less than 50mA.		
High Temperature	Appearance : No abnormal exterior appearance	1,000hrs @ 125℃, 150% Rated Voltage,		
Operating Life	Capacitance Change Within ±12.5 %	Initial Measurement 2*		
	Tan δ :0.075 max.	Final Measurement 4*		
	IR ∶More than 1,000 № or 50 №× <i>µ</i> F	Measurement at 24±2hrs after test conclusion		
	Whichever is smaller	The charge/discharge current is less than 50mA.		

	Performance	Test condition				
External Visual	No abnormal exterior appearance	Microscope ('10)				
Physical Dimension	Within the specified dimensions	Using The calipers				
Mechanical Shock	Appearance : No abnormal exterior appearance	Three shocks in each direction should be applied along				
	Capacitance Change Within ±10 %	3 mutually perpendicular axes of the test specimen (18 shocks)				
	Tan δ, IR : Initial spec.	Peak value   Duration   Wave   Velocity				
		1,500G 0.5ms Half sine 4.7m/sec				
		Initial Measurement 2*				
		Final Measurement 5*				
Vibration	Appearance : No abnormal exterior appearance	5g's for 20min., 12cycles each of 3 orientations,				
	Capacitance Change Within ±10 %	Use 8"×5" PCB 0.031" Thick 7 secure points on one long side				
	Tan δ, IR : Initial spec.	and 2 secure points at corners of opposite sides. Parts mounted				
		within 2" from any secure point. Test from 10~2,000Hz.				
		Initial Measurement 2*				
		Final Measurement 5*				
Resistance to	Appearance : No abnormal exterior appearance	preheating : 150°C for 60~120 sec.				
Solder Heat	Capacitance Change Within ±10 %	Solder pot : 260±5 ℃, 10±1sec.				
	Tan δ, IR : Initial spec.	Initial Measurement 2*				
		Final Measurement 3*				
ESD	Appearance : No abnormal exterior appearance	AEC-Q200-002 or ISO/DIS10605				
	Capacitance Change Within ±10 %	Initial Measurement 2*				
	Tan δ, IR : Initial spec.	Final Measurement 4*				
Solderability	95% of the terminations is to be soldered	a) Preheat at 155°C for 4 hours, Immerse in solder for 5s at 245±5°C				
	evenly and continuously	b) Steam aging for 8 hours, Immerse in solder for 5s at 245±5 °C				
		c) Steam aging for 8 hours, Immerse in solder for 120s at 260±5°C				
		solder : a solution ethanol and rosin				
Electrical	Capacitance : Within specified tolerance	*A capacitor prior to measuring the capacitance is heat treated at				
Characterization	Tan δ :0.05 max.	150 +0/-10°C for 1hour and maintained in ambient air for 24±2 hours				
	IR(25℃): More than 10,000 № or 500 №×μF	The Capacitance / D.F. should be measured at 25 ℃,				
	Whichever is smaller	$1^{\text{kHz}} \pm 10\%$ , $1 \pm 0.2 \text{ Vrms}$				
	IR(125 °C) More than 1,000 № or 10 №× µF	I.R. should be measured with a DC voltage not exceeding				
	Whichever is smaller	Rated Voltage @25℃, @125℃ for 60~120 sec.				
	Dielectric Strength	Dielectric Strength : 250% of the rated voltage for 1~5 seconds				
Board Flex	Appearance : No abnormal exterior appearance	Bending to the limit, 3 mm for 60 seconds 1*				
	Capacitance Change Within ±10 %	Initial Measurement 2*				
		Final Measurement 5*				
Terminal	Appearance : No abnormal exterior appearance	10 N, for 60 sec.				
Strength(SMD)	Capacitance Change Within ±10 %	Initial Measurement 2*				
		Final Measurement 5*				
Beam Load	Destruction value should be exceed 20 N	Beam speed: 0.5±0.05 mm/sec				
Temperature	X7R					
Characteristics	From -55 $^{\circ}$ to 125 $^{\circ}$ , Capacitance change shou	lld be within ±15%				

#### D. Recommended Soldering method :

Reflow ( Reflow Peak Temperature : 260 +0/-5°C, 30sec. ), Meet IPC/JEDEC J-STD-020 D Standard

- \*1 : The figure indicates typical specification. Please refer to individual specifications.
- \*2 : Initial measurement : Perform a heat treatment at 150 +0/-10  $^{\circ}\mathrm{C}$  for one hour after soldering process. and then let sit for 24±2 hours at room temperature. Perform the initial measurement.
- $^{\star}3$ : Final measurement : Let sit for 24 $\pm$ 2 hours at room temperature after test conclusion, then measure.
- \*4 : Final measurement : Perform a heat treatment at 150 +0/-10 °C for one hour after soldering process. and then let sit for 24±2 hours at room temperature. Perform the initial measurement.
- \*5 : Final measurement : Let measure within 24 hours at room temperature after test conclusion.



A Product specifications included in the specifications are effective as of March 1, 2013.

Please be advised that they are standard product specifications for reference only.

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- ⑤ Power plant control equipment
- 6 Atomic energy-related equipment
- ① Undersea equipment
- 8 Traffic signal equipment
- Data-processing equipment
- @ Electric heating apparatus, burning equipment
- Safety equipment
- @ Any other applications with the same as or similar complexity or reliability to the applications